# Notification about the transfer of the semiconductor business

The semiconductor business of Panasonic Corporation was transferred on September 1, 2020 to Nuvoton Technology Corporation (hereinafter referred to as "Nuvoton"). Accordingly, Panasonic Semiconductor Solutions Co., Ltd. became under the umbrella of the Nuvoton Group, with the new name of Nuvoton Technology Corporation Japan (hereinafter referred to as "NTCJ").

In accordance with this transfer, semiconductor products will be handled as NTCJ-made products after September 1, 2020. However, such products will be continuously sold through Panasonic Corporation.

Publisher of this Document is NTCJ.

If you would find description "Panasonic" or "Panasonic semiconductor solutions", please replace it with NTCJ.

Except below description page
 "Request for your special attention and precautions in using the technical information and semiconductors described in this book"

Nuvoton Technology Corporation Japan

Product Standards	MIP5310MTSCF		
	Total pages	Page	
	9	2	

Туре	Silicon MOSFET type Integrated Circuit				
Application	For Switching Power Supply Control				
Structure	CMOS type	CMOS type			
Equivalent Circuit	See Figure 7	See Figure 7			
Package	DIP7-A1-B	Marking	MIP531		

### A. ABSOLUTE MAXIMUM RATINGS (Ta=25°C±3°C)

No.	Item	Symbol	Ratings	Unit	Note
1	DRAIN Voltage				
		VD	<b>−</b> 0.3 <b>∼</b> 700	V	<b>※</b> 1:
2	VIN Voltage	VIN	−0.3 <b>~</b> 650	٧	It is guaranteed within the pulse as below. Leading Edge Blanking
3	VDD Voltage	VDD	-0.3 ∼ 8	V	Pulse + Current Limit Delay
4	VDD current	IDD	30	mA	ton(BLK)+td(OCL)
5	Feedback Voltage	VFB	<b>−0.3</b> ~ 8	V	
6	Output Peak Current	IDP	1.25(※1)	Α	
7	Junction Temperature	Tj	150	°C	
8	Storage Temperature	Tstg	−55 ~ +150	°C	

## B. Recommended Operating Conditions

No.	Item	Symbol	conditions	Unit	Note
1	Junction Temperature				
		Tj	$-40 \sim +125$	°C	

Industrial Devices Company, Panasonic Corporation

Product Standards	MIP5310MTSCF		
	Total pages	Page	
	9	3	

C. ELECTRICAL CHARACTERISTICS Measure condition (Ta=25°C±3°C)

C. ELI	CIRICAL CHARACTERISTICS	Measure cor	idition (Ta-25 C±3 C)				
No.	Item	Symbol	Measure Condition (Figure 1)	Тур.	Min.	Max.	Unit
[CON	FROL FUNCTIONS】 * Design Guarantee	Item ** Re	ference Value Item				
1	Output Frequency	fosc	$\%$ Figure 6 VDD=VDD(ON), IFB=-20 $\mu$ A,VD=ILIMIT condition,	100	90	110	kHz
2	Jitter Frequency Deviation	d_fosc	$\%$ Figure 6 VDD=VDD(ON), IFB=-20 $\mu$ A,VD=ILIMIT condition,	5.5	-	_	kHz
**3	Jitter Frequency Modulation Rate	fM	$\%$ Figure 6 VDD=VDD(ON), IFB=-20 $\mu$ A,VD=ILIMIT condition,	200	-	-	Hz
4	Maximum On-state Time	MAX(ON)	VDD=VDD(ON), IFB=-20 $\mu$ A, VD=5 V,	13	9.4	16.6	μs
5	VDD start Voltage	VDD(ON)	VD=5 V, IFB=-20 μA,	5.9	5.4	6.4	V
6	VDD stop Voltage	VDD(UV)	VD=5 V, IFB=-20 <i>μ</i> A,	4.9	4.4	5.4	V
7	VDD start/stop Voltage Hysteresis	⊿VDD	VDD(ON) – VDD(UV)	1.0	0.5	1.5	V
8	VDD clamp Voltage	VDD(CLP)	IDD=3 mA	6.2	5.6	6.8	V
9	Delta VDD clamp	D_VDD(CLP)	VDD(CLP)-VDD(ON)	0.3	0.05	0.7	V
10	Feedback Current	IFB_STB	ON→OFF VDD=VDD(ON),VD=ILIMIT condition,	-100	-155	-45	μΑ
11	Feedback Current Hysteresis	IFB(HYS)	OFF→ON VDD=VDD(ON),VD=ILIMITcondition,	4	_	-	μΑ
12	FB Pin Voltage	VFB	VDD=VDD(ON), IFB= $-20~\mu$ A, VD=ILIMIT condition,	2	1.65	2.35	V
13	FB Pin Voltage at light load	VFB_STB	VDD=VDD(ON), IFB=IFB_STB, VD=ILIMIT condition,	1.75	1.4	2.1	٧
14	FB Pin Grounded Current	IFB_GND	VDD=VDD(ON), VFB=0 V, VD=ILIMIT condition,	-360	-500	-240	μΑ
15	Pre-start Consuming Current	IDD(SB)	VDD=VDD(ON)–0.3 V, IFB=–20 $\mu$ A, VD=5 V,	0.22	0.16	0.28	mA
16	Operating Circuit Consuming Current	IDD	VDD=VDD(ON), IFB=-20 μ A, VD=ILIMIT condition,	0.38	0.24	0.52	mA
17	Operating Circuit Consuming Current		VDD=VDD(ON), IFB=IFB_STB,				
18	at light load  VDD Charging Current	IDD(OFF)	VD=ILIMIT condition, VDD=0 V, VIN=40 V,	0.38 -11	0.20 -16.5	0.56 -5.5	mA mA
10	Onarging Ourrent	Ich2	VDD=5 V, VIN=40 V,	-11 -8	-10.5 -12	-5.5 -4	mA

	Product Standards	MIP5310MTSCF		
i i oddot otalidai do		Total pages	Page	
		9	4	

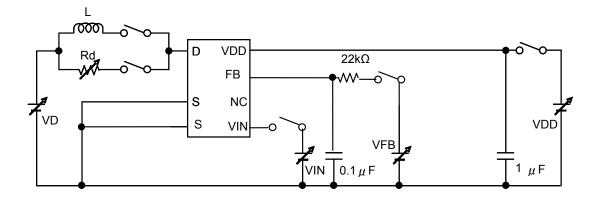
No.	Item	Symbol	Measure Condition (Figure 1)	Тур.	Min.	Max.	Unit
[CIRC	UIT PROTECTIONS】 * Design Guarante	e Item ** Re	ference Value Item	ı			<u> </u>
19	Self Protection Current Limit	ILIMIT	XFigure 4 ton=30 % duty cycle,  VDD=VDD(ON),VFB=3 V, VD=adjust,	0.35	0.315	0.385	А
**20	When OCP Detected Oscillation Off-state Time	Tdet(OC)	VDD=VDD(ON), VFB=3 V, VD=adjusted,	1	-	-	μs
**21	Light-load Output Current	ID(OFF)	※Figure 4 ton=30 % duty cycle, VDD=VDD(ON),IFB=IFB_STB+5 μ A, VD=adjust,	140	-	-	mA
22	FB Pin Over Load Charging Current	IFBch	VDD=VDD(ON), VFB=3 V, VD=ILIMIT condition,	-8	-11	-5	μΑ
23	FB Pin Over Load Protection Voltage	VFB(OLP)	VDD=VDD(ON), VD=ILIMIT condition,	4.3	3.7	4.8	V
24	VFB Hysteresis	∠VFB	VFB(OLP)-VFB	2.3	1.45	3.15	V
25	OLP VDD Oscillation Count	OLP_CNT			8	•	_
*26	Leading Edge Blanking Delay	ton(BLK)		330	260	400	ns
*27	Current Limit Delay	td(OCL)		100	65	135	ns
28	VDD current at latch stop	IDD(OV)	ON→OFF IFB=−20 μ A, VD=5 V,	14	9	21	mA
*29	Thermal Shutdown Temperature	ТОТР		140	130	150	°C
	Thermal Shutdown Temperature Hysteresis	⊿тотр		70	_	_	°C
30	Power-up Reset Threshold Voltage	VDDreset		2.4	1.5	3.3	V

Industrial Devices Company, Panasonic Corporation

Product Standards	MIP5310MTSCF		
	Total pages	Page	
	9	5	

No.	Item	Symbol	Measure Condition (Figure 1)	Тур.	Min.	Max.	Unit
【High \	/oltage Input】 * Design Guarantee Item	** Reference	e Value Item				
31	Off-state VIN Pin Leakage Current	IIN(LEAK)	VIN=600 V, IDD=IDD(OV)	10	_	20	μΑ
32	VIN Pin Voltage	BVVIN	IIN=100 μ A, IDD=IDD(OV)	-	650	_	٧
33	Minimum VIN Voltage	VIN(MIN)	IFB=-20 μ A, VD=5 V,	_	50	_	٧
[Outpu	t】 * Design Guarantee Item ** Refere	nce Value Ite	m				
34	ON-State Resistance	RDS(ON)	VDD=VDD(ON), IFB= $-20 \mu$ A, IDS= $100 \text{ mA}$ ,	16	_	22	Ω
35	OFF-State Current	IDSS	IDD=IDD(OV), IFB=-20 μ A, VD=650 V,	2	_	20	μΑ
36	Breakdown Voltage	VDSS	IDD=IDD(OV), IFB=-20 $\mu$ A, ID=100 $\mu$ A,	_	700	-	٧
**37	Rise Time	tr	$\%$ Figure 5 VDD=VDD(ON), IFB=-20 $\mu$ A, VD=5 V,	50	_	_	ns
**38	Fall Time	tf	%Figure 5 VDD=VDD(ON), IFB=-20 $\mu$ A, VD=5 V,	50	_	_	ns

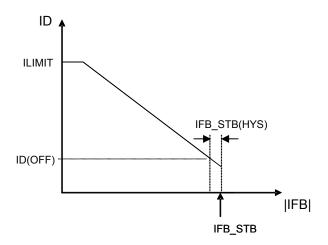
[Figure 1 : Measure Circuit]



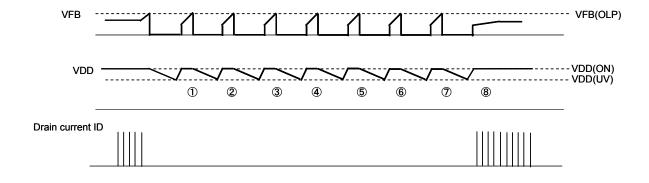
Industrial Devices Company, Panasonic Corporation

Product Standards	MIP5310MTSCF		
	Total pages	Page	
	9	6	

[Figure 2 : ID vs IFB Measurement]



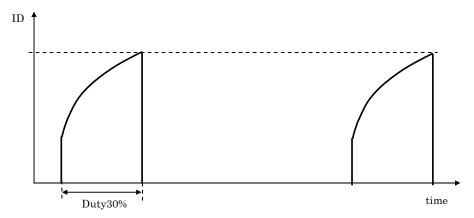
[Figure 3 : Over-Load Detected Measurement]



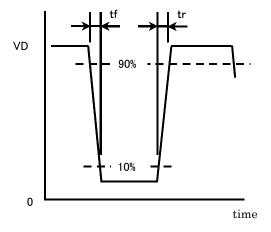
Industrial Devices Company, Panasonic Corporation

Product Standards	MIP5310MTSCF			
	Total pages	Page		
	9	7		

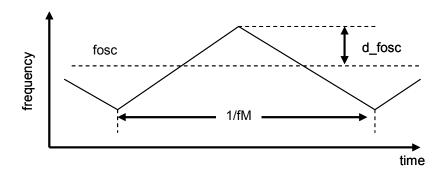
 $\begin{tabular}{ll} \textbf{Figure 4}: & \textbf{ILIMIT}, \textbf{ID}(\textbf{OFF}) \textbf{ Measurement} \end{tabular}$ 



[Figure 5: tr, tf Measurement]

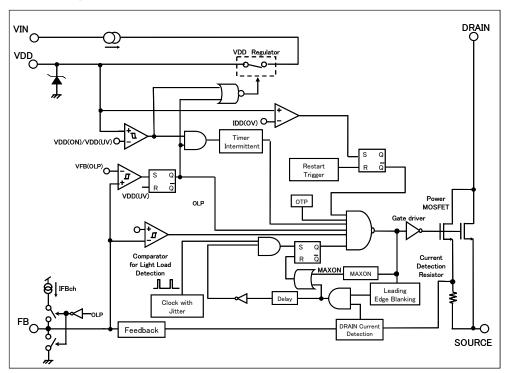


[Figure  $6: d_{fosc}$ , fM Measurement]

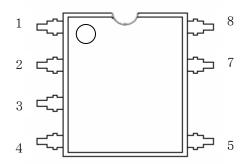


	Product Standards	MIP5310MTSCF	
	Total pages	Page	
		9	8

[Figure 7: Block Diagram]



[Figure 8: Pin Layout]



Pin No.	Terminal Name	
1	VIN	
2	NC	
3	FB	
4	VDD	
5	DRAIN	
6	_	
7	SOURCE	
8	SOURCE	

Product Standards	MIP5310MTSCF	
	Total pages	Page
	9	9

#### [Precautions for Use 1]

Connect a Ceramic Capacitor (over 1  $\mu$  F) between VDD Pin and SOURCE.

#### [Precautions for Use 2]

The IPD has risks for break-down or burst or giving off smoke in following conditions. Avoid the following use. Fuse should be added at the input side or connect zener diode between control pin and GND, etc as a countermeasure to pass regulatory Safety Standard. Concrete countermeasure could be provided individually. However, customer should make the final judgment.

- (1) DRAIN Pin and VIN Pin reversely connect into power board.
- (2) DRAIN Pin and VIN Pin short circuit.
- (3) DRAIN Pin and FB Pin short circuit.
- (4) DRAIN Pin and VDD Pin short circuit.
- (5) VIN Pin and FB Pin short circuit.
- (6) VIN Pin and VDD Pin short circuit.

Industrial Devices Company, Panasonic Corporation

Established: 2012-10-25
Revised: ###-##-##

Downloaded From Oneyac.com

# Request for your special attention and precautions in using the technical information and semiconductors described in this book

- (1) If any of the products or technical information described in this book is to be exported or provided to non-residents, the laws and regulations of the exporting country, especially, those with regard to security export control, must be observed.
- (2) The technical information described in this book is intended only to show the main characteristics and application circuit examples of the products. No license is granted in and to any intellectual property right or other right owned by Panasonic Corporation, Nuvoton Technology Corporation Japan or any other company. Therefore, no responsibility is assumed by our company as to the infringement upon any such right owned by any other company which may arise as a result of the use of technical information de-scribed in this book.
- (3) The products described in this book are intended to be used for general applications (such as office equipment, communications equipment, measuring instruments and household appliances), or for specific applications as expressly stated in this book.
  - Please consult with our sales staff in advance for information on the following applications, moreover please exchange documents separately on terms of use etc.: Special applications (such as for in-vehicle equipment, airplanes, aerospace, automotive equipment, traffic signaling equipment, combustion equipment, medical equipment and safety devices) in which exceptional quality and reliability are required, or if the failure or malfunction of the products may directly jeopardize life or harm the human body.
  - Unless exchanging documents on terms of use etc. in advance, it is to be understood that our company shall not be held responsible for any damage incurred as a result of or in connection with your using the products described in this book for any special application.
- (4) The products and product specifications described in this book are subject to change without notice for modification and/or improvement. At the final stage of your design, purchasing, or use of the products, therefore, ask for the most upto-date Product Standards in advance to make sure that the latest specifications satisfy your requirements.
- (5) When designing your equipment, comply with the range of absolute maximum rating and the guaranteed operating conditions (operating power supply voltage and operating environment etc.). Especially, please be careful not to exceed the range of absolute maximum rating on the transient state, such as power-on, power-off and mode-switching. Otherwise, we will not be liable for any defect which may arise later in your equipment.
  Even when the products are used within the guaranteed values, take into the consideration of incidence of break down and failure mode, possible to occur to semiconductor products. Measures on the systems such as redundant design, arresting the spread of fire or preventing glitch are recommended in order to prevent physical injury, fire, social damages, for example, by using the products.
- (6) Comply with the instructions for use in order to prevent breakdown and characteristics change due to external factors (ESD, EOS, thermal stress and mechanical stress) at the time of handling, mounting or at customer's process. We do not guarantee quality for disassembled products or the product re-mounted after removing from the mounting board. When using products for which damp-proof packing is required, satisfy the conditions, such as shelf life and the elapsed time since first opening the packages.
- (7) When reselling products described in this book to other companies without our permission and receiving any claim of request from the resale destination, please understand that customers will bear the burden.
- (8) This book may be not reprinted or reproduced whether wholly or partially, without the prior written permission of our company.

No.070920

# 单击下面可查看定价,库存,交付和生命周期等信息

>>Panasonic(松下)